



### Layer Stackup

Cu		Prepreg/Core
35μm		
35μm		Prepreg 288μm (2116+7628)
35μm		Core 710μm
35μm		Prepreg 288μm (2116+7628)
35μm		

### Impedances

Signal Layer	Reference Layer	Target Impedance	Trace Width
Top	Midlayer 1	50ohm	500μm